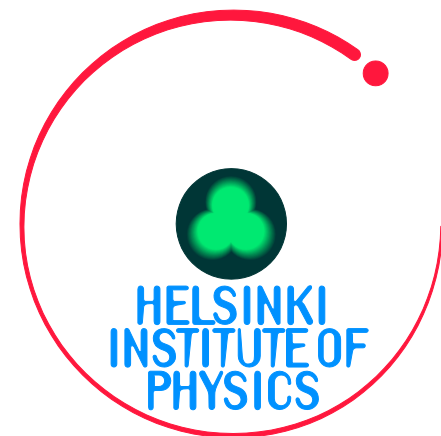


Future trends of radiation detector technologies



Outline



Introduction

Helsinki Detector Laboratory
Types of radiation detectors

Applications of radiation detectors

Trends in radiation detecting

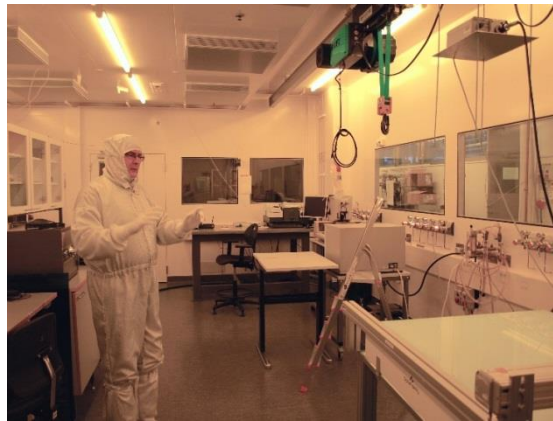
Science
Health
Safety, Security & Safeguards



Helsinki Detector Laboratory

HELSINKI
INSTITUTE OF
PHYSICS

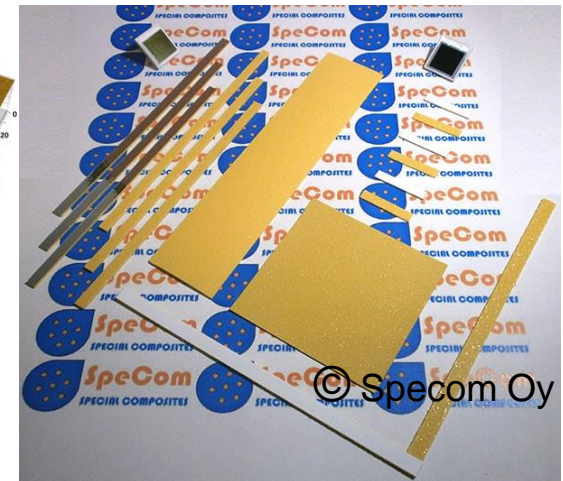
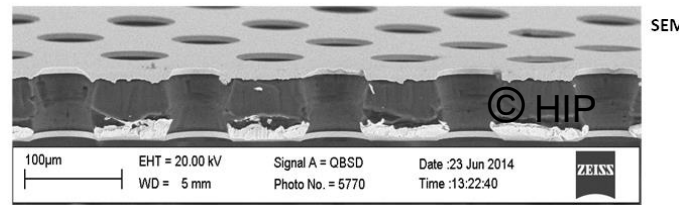
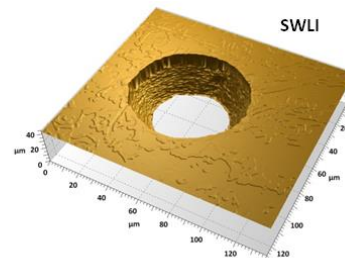
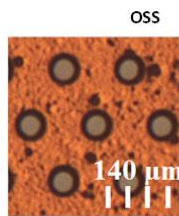
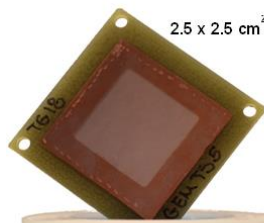
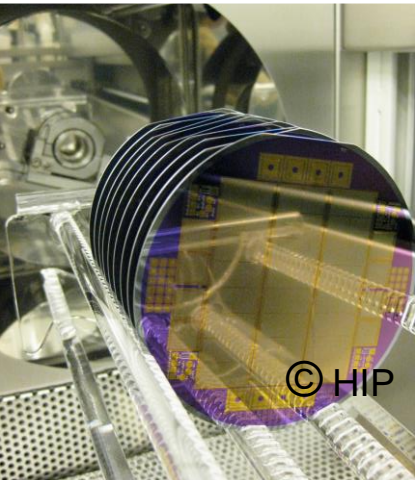
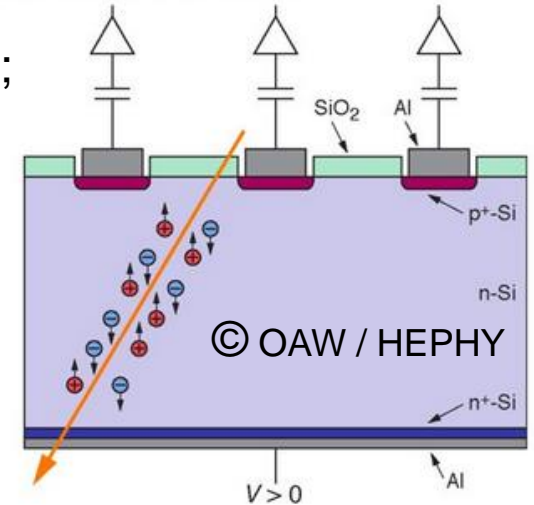
- Permanent infrastructure with premises, equipment and personnel for detector development, prototyping, assembly and quality assurance;
- Common Infrastructure of Helsinki Institute of Physics (HIP) and University of Helsinki / Department of Physics;
- Center for instrumentation of Finnish CERN and FAIR activities;
- Cooperation with universities, research institutes and companies (e.g. Micronova, JYFL, LUT, CERN);
- Education and outreach.





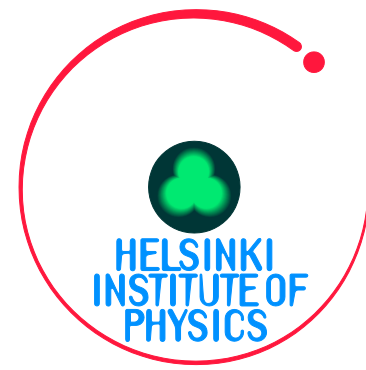
Types of radiation detectors

1. Semiconductor detectors, eg. Si, Ge, GaAs, CdTe;
2. Gaseous detectors, eg. proportional counters, Gas Electron Multiplier (GEM) detectors;
3. Scintillators, e.g. metamaterials (SMM).





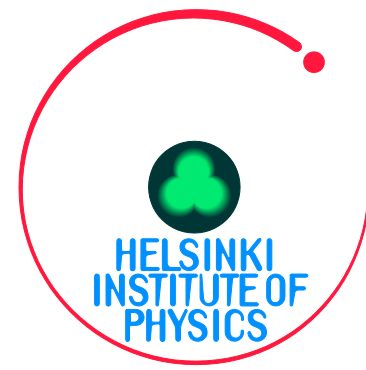
Applications of radiation detectors



- Science
 - particle physics (e.g. CERN)
 - nuclear physics (e.g. FAIR)
 - material physics (e.g. ESRF, XFEL)
 - astrophysics (e.g. satellites, ESO, ESA)
 - dating, archeology (e.g. C-14)
- Health
 - medical imaging (e.g. CT, PET, MRI)
 - nuclear medicine
- Safety, security and safeguards
- Industry (e.g. food preservation, imaging)



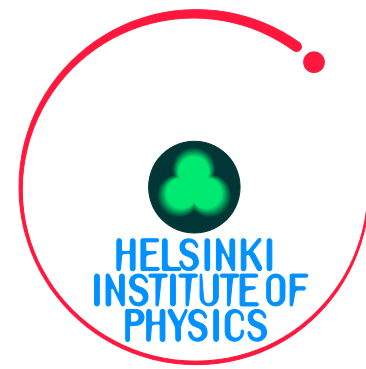
Challenges in science



- Increased **radiation hardness**, due to increased luminosity;
- Decreased physical dimensions of detector **segmentation**, i.e. increased granularity;
- Custom-made detector solutions;
- Demands for cheaper prizes, longer lifetime, consistent detectors and less maintenance (cost-effectiveness);
- Consecutive demands for **read-out electronics, data acquisition, interconnection technologies, and quality assurance**;
- Long project timelines:
 - projects and upgrades typically appear in 5-10 year cycles;
 - thus, no steady cash flow industrial partners;
 - and, gained expertise does not accumulate (brain drain).



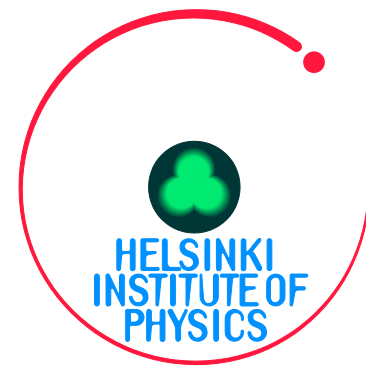
Trends in science / semiconductor detectors



- Detector technologies foreseen to improve **radiation hardness**:
 - from n-type detectors to p-type detectors ($\mu_e > \mu_h$, no SCSi);
 - availability of p-type Magnetic Czochralski silicon (**p-MCz Si**);
 - p-MCz Si is radiation hard due to high oxygen concentration;
- Technologies foreseen provide **finer segmentation**:
 - deep submicron Atomic Layer Deposition (**ALD**) technology provides very high densities of capacitance and resistance;
 - in addition, ALD helps to resolve the accumulation of positive oxide charge in Si-oxide interface in p-type detectors;
- Ultra-fast silicon detectors with timing resolution, based on the concept of Low Gain Avalanche Detector (**LGAD**).



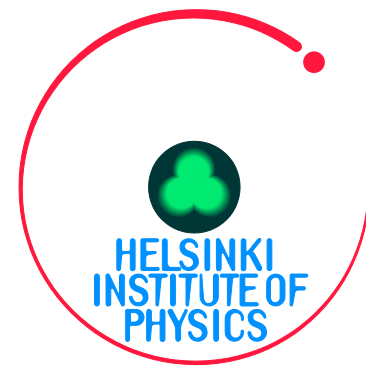
Trends in science / gaseous detectors



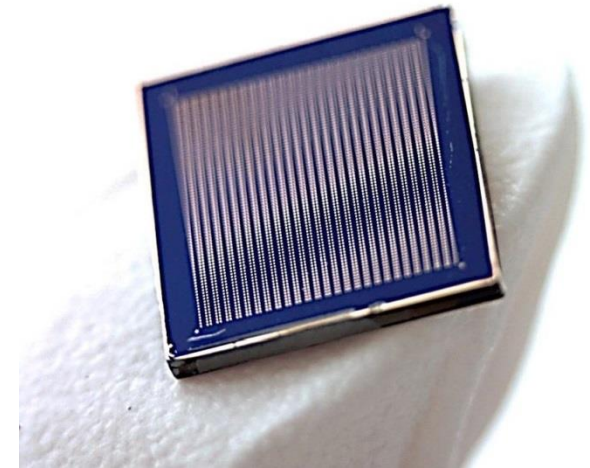
- Picosecond Micro Patterned Gas Detectors (**MPGDs**):
 - i.e. hybrid detectors combining micro-pattern gaseous detectors with Cherenkov light detection via a photocathode;
 - objective is large surface detectors capable of timing resolution of few tens of picoseconds;
- Time Projection Chambers (**TPC**);
- Large area detectors for muon detection;
- R&D ongoing to better understand the physics of gaseous detectors and to develop new exotic detectors for rare events (e.g. dark photons).



Trends in medical imaging

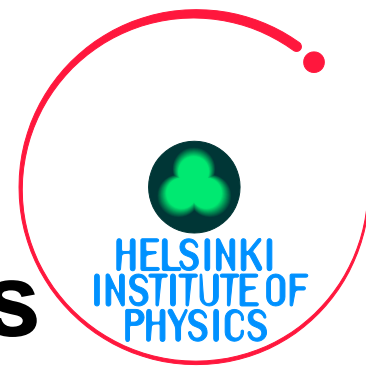


- Requirement for increased accuracy and decreased radiation dose;
- Direct detection of X-rays (i.e. without scintillator) -> significant improvement in cancer diagnostics and treatment (Spectral/Color imaging);
- Silicon NOT suitable for direct x-ray detection (limited stopping power);
- **CdTe** still with challenges in crystal growth (commercialization requires significant R&D from scientific community);
- **GaAs**, especially for the increased need of mammography, still with challenges in semiconductor manufacturing process;
- Commercialization of CdTe and GaAs still requires significant R&D from scientific community.





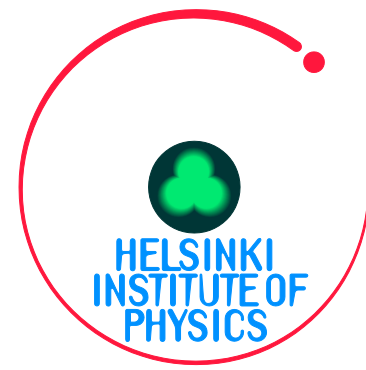
Trends in safety, security and safeguards



- 2D/3D imaging;
- User-free sensing:
 - non-attended operations (safeguards);
 - remote sensing (security);
 - automated analysis;
- Increased amount of sensing:
 - hidden sensors;
 - diffused networks;
- Muon imaging:
 - penetrating radiation;
 - e.g. loaded nuclear fuel casks, cargo containers, train cars.



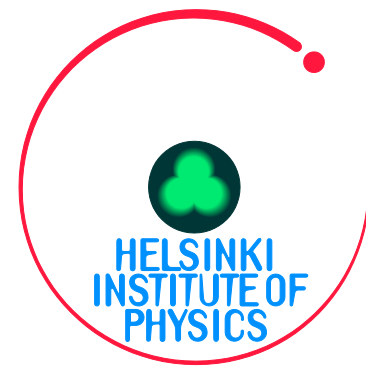
Trends in quality assurance (QA)



- Reliable quality assurance (optical and electrical) prior to installation is essential to guarantee reliable performance of detectors, interconnections and electronics;
- Increased detector granularity calls for increased granularity in QA;
- Trends in the future:
 - **traceable nanometrology** with novel measurement techniques and standards (ref. EURAMET / MIKES);
 - **super-resolution** technologies with e.g. super-resolution microscopy and image processing (ref. Nobel Prize in Chemistry 2014);
 - **neural networks** to process vast amount of data.



Summary



- Detector technologies developed for particle and nuclear physics are widely applied in:
 - medical imaging;
 - safety, security and safeguards;
- Trends in radiation detectors:
 - improved radiation hardness;
 - decreased physical dimensions;
 - semiconductor materials p-MCz Si, GaAs, CdTe.
- Consecutively, decrease in physical dimensions sets demands for:
 - read-out electronics & data acquisition;
 - interconnection technologies;
 - QA (nanometrology, super-resolution, neural networks).